

Notice of References Cited

Application/Control No.

09/845,327

Applicant(s)/Patent Under

Reexamination

OSAKADA, AKIYOSHI

Examiner

James Mitchell

Art Unit

2822

Page 1 of 1

U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
	A	US-6,316,826	11-2001	Yamamoto et al.	257/705
	B	US-2001/0004132	06-2001	Bergstedt et al.	257/728
	C	US-5,167,869	12-1992	Nebe et al.	252/514
	D	US-4,907,067	03-1990	Derryberry	357/74
	E	US-4,546,478	10-1985	Shimizu et al.	372/36
	F	US-			
	G	US-			
	H	US-			
	I	US-			
	J	US-			
	K	US-			
	L	US-			
	M	US-			

FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
	N	JP2000049253	02-2000	Japan	Yoshio	---
	O					
	P					
	Q					
	R					
	S					
	T					

NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	Rajen Chanchani, "Temperature Dependence of Thermal Expansion of Ceramics and Metals for Electronic Packages", IEEE 1990, Vol. 13 No.4
	V	
	W	
	X	

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.